



Welcome to E-XFL.COM

What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	HC08
Core Size	8-Bit
Speed	8MHz
Connectivity	I ² C, IRSCI, SPI
Peripherals	LCD, LVD, POR, PWM
Number of I/O	48
Program Memory Size	24KB (24K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	768 x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	A/D 6x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	80-LQFP
Supplier Device Package	80-FQFP (12x12)
Purchase URL	https://www.e-xfl.com/pro/item?MUrl=&PartUrl=mc68hc908lj24cpk

Section 21. Computer Operating Properly (COP)

21.1	Contents	415
21.2	Introduction	415
21.3	Functional Description	416
21.4	I/O Signals	417
21.4.1	ICLK	417
21.4.2	STOP Instruction	417
21.4.3	COPCTL Write	417
21.4.4	Power-On Reset	417
21.4.5	Internal Reset	418
21.4.6	Reset Vector Fetch	418
21.4.7	COPD (COP Disable)	418
21.4.8	COPRS (COP Rate Select)	418
21.5	COP Control Register	419
21.6	Interrupts	419
21.7	Monitor Mode	419
21.8	Low-Power Modes	419
21.8.1	Wait Mode	420
21.8.2	Stop Mode	420
21.9	COP Module During Break Mode	420

Section 22. Low-Voltage Inhibit (LVI)

22.1	Contents	421
22.2	Introduction	421
22.3	Features	421
22.4	Functional Description	422
22.4.1	Polled LVI Operation	424
22.4.2	Forced Reset Operation	424
22.4.3	Voltage Hysteresis Protection	424
22.4.4	LVI Trip Selection	425
22.5	LVI Status Register	425

List of Figures

Figure	Title	Page
1-1	MC68HC908LJ24 Block Diagram	41
1-2	80-Pin QFP and LQFP Pin Assignment	42
1-3	64-pin QFP and LQFP Pin Assignment	43
1-4	Power Supply Bypassing	44
2-1	Memory Map	51
2-2	Control, Status, and Data Registers	52
4-1	FLASH I/O Register Summary	70
4-2	FLASH Control Register (FLCR)	71
4-3	FLASH Programming Flowchart	75
4-4	FLASH Block Protect Register (FLBPR)	77
5-1	CONFIG Registers Summary	80
5-2	Configuration Register 1 (CONFIG1)	81
5-3	Configuration Register 2 (CONFIG2)	82
6-1	CPU Registers	87
6-2	Accumulator (A)	87
6-3	Index Register (H:X)	88
6-4	Stack Pointer (SP)	88
6-5	Program Counter (PC)	89
6-6	Condition Code Register (CCR)	90
7-1	Oscillator Module Block Diagram	104
8-1	CGM Block Diagram	112
8-2	CGM I/O Register Summary	113
8-3	CGM External Connections	123
8-4	PLL Control Register (PCTL)	126

Figure	Title	Page
17-11	1/4 Duty LCD Frontplane Driver Waveforms (continued)	364
17-12	7-Segment Display Example	365
17-13	BP0–BP2 and FP0–FP2 Output Waveforms for 7-Segment Display Example	366
17-14	"f" Segment Voltage Waveform	367
17-15	"e" Segment Voltage Waveform	367
17-16	LCD Control Register (LCDCR)	368
17-17	LCD Clock Register (LCDCLK)	370
17-18	LCD Data Registers 1–17 (LDAT1–LDAT17)	372
18-1	I/O Port Register Summary	376
18-2	Port A Data Register (PTA)	380
18-3	Data Direction Register A (DDRA)	381
18-4	Port A I/O Circuit	382
18-5	Port B Data Register (PTB)	383
18-6	Data Direction Register B (DDRB)	385
18-7	Port B I/O Circuit	385
18-8	Port B LED Control Register (LEDB)	386
18-9	Port C Data Register (PTC)	387
18-10	Data Direction Register C (DDRC)	388
18-11	Port C I/O Circuit	388
18-12	Port C LED Control Register (LEDC)	389
18-13	Port D Data Register (PTD)	390
18-14	Data Direction Register D (DDRD)	392
18-15	Port D I/O Circuit	392
18-16	Port E Data Register (PTE)	394
18-17	Data Direction Register E (DDRE)	395
18-18	Port E I/O Circuit	395
18-19	Port E LED Control Register (LEDE)	396
18-20	Port F Data Register (PTF)	397
18-21	Data Direction Register F (DDRF)	398
18-22	Port F I/O Circuit	398
18-23	Port F LED Control Register (LEDF)	399
19-1	IRQ Module Block Diagram	403
19-2	IRQ I/O Port Register Summary	403

Memory Map

Addr.	Register Name	Bit 7	6	5	4	3	2	1	Bit 0	
\$0000	Port A Data Register (PTA)	Read:	PTA7	PTA6	PTA5	PTA4	PTA3	PTA2	PTA1	PTA0
		Write:								
		Reset:	U	U	U	U	U	U	U	U
\$0001	Port B Data Register (PTB)	Read:	PTB7	PTB6	PTB5	PTB4	PTB3	PTB2	PTB1	PTB0
		Write:								
		Reset:	U	U	U	U	U	U	U	U
\$0002	Port C Data Register (PTC)	Read:	PTC7	PTC6	PTC5	PTC4	PTC3	PTC2	PTC1	PTC0
		Write:								
		Reset:	U	U	U	U	U	U	U	U
\$0003	Port D Data Register (PTD)	Read:	PTD7	PTD6	PTD5	PTD4	PTD3	PTD2	PTD1	PTD0
		Write:								
		Reset:	U	U	U	U	U	U	U	U
\$0004	Data Direction Register A (DDRA)	Read:	DDRA7	DDRA6	DDRA5	DDRA4	DDRA3	DDRA2	DDRA1	DDRA0
		Write:								
		Reset:	0	0	0	0	0	0	0	0
\$0005	Data Direction Register B (DDRB)	Read:	DDRB7	DDRB6	DDRB5	DDRB4	DDRB3	DDRB2	DDRB1	DDRB0
		Write:								
		Reset:	0	0	0	0	0	0	0	0
\$0006	Data Direction Register C (DDRC)	Read:	DDRC7	DDRC6	DDRC5	DDRC4	DDRC3	DDRC2	DDRC1	DDRC0
		Write:								
		Reset:	0	0	0	0	0	0	0	0
\$0007	Data Direction Register D (DDRD)	Read:	DDRD7	DDRD6	DDRD5	DDRD4	DDRD3	DDRD2	DDRD1	DDRD0
		Write:								
		Reset:	0	0	0	0	0	0	0	0
\$0008	Port E Data Register (PTE)	Read:	PTE7	PTE6	PTE5	PTE4	PTE3	PTE2	PTE1	PTE0
		Write:								
		Reset:	U	U	U	U	U	U	U	U
\$0009	Data Direction Register E (DDRE)	Read:	DDRE7	DDRE6	DDRE5	DDRE4	DDRE3	DDRE2	DDRE1	DDRE0
		Write:								
		Reset:	0	0	0	0	0	0	0	0

U = Unaffected X = Indeterminate = Unimplemented R = Reserved

Figure 2-2. Control, Status, and Data Registers (Sheet 1 of 13)

PCEH — Port C Enable High Nibble

Setting PCEH configures the PTC4/FP23–PTC7/FP26 pins for LCD frontplane driver use. Reset clears this bit.

- 1 = PTC4/FP23–PTC7/FP26 pins configured as LCD frontplane driver pins: FP23–FP26
- 0 = PTC4/FP23–PTC7/FP26 pins configured as standard I/O pins: PTC4–PTC7

PCEL — Port C Enable Low Nibble

Setting PCEL configures the PTC0/FP19–PTC3/FP22 pins for LCD frontplane driver use. Reset clears this bit.

- 1 = PTC0/FP19–PTC3/FP22 pins configured as LCD frontplane driver pins: FP19–FP22
- 0 = PTC0/FP19–PTC3/FP22 pins configured as standard I/O pins: PTC0–PTC3

LVISEL[1:0] — LVI Operating Mode Selection

LVISEL[1:0] selects the voltage operating mode of the LVI module. (See [Section 22. Low-Voltage Inhibit \(LVI\)](#).) The voltage mode selected for the LVI should match the operating V_{DD} . See [Section 24. Electrical Specifications](#) for the LVI voltage trip points for each of the modes.

Table 5-1. LVI Trip Point Selection

LVISEL1	LVISEL0	Operating Mode
0	0	Reserved
0	1	3.3V ⁽¹⁾
1	0	5V
1	1	Reserved

Notes:

- 1. Default setting after a power-on-reset.

8.3 Features

Features of the CGM include:

- Phase-locked loop with output frequency in integer multiples of an integer dividend of the crystal reference
- Low-frequency crystal operation with low-power operation and high-output frequency resolution
- Programmable prescaler for power-of-two increases in frequency
- Programmable hardware voltage-controlled oscillator (VCO) for low-jitter operation
- Automatic bandwidth control mode for low-jitter operation
- Automatic frequency lock detector
- CPU interrupt on entry or exit from locked condition
- Configuration register bit to allow oscillator operation during stop mode

8.4 Functional Description

The CGM consists of three major sub-modules:

- Oscillator module — The oscillator module generates the constant reference frequency clock, CGMRCLK (buffered CGMXCLK).
- Phase-locked loop (PLL) — The PLL generates the programmable VCO frequency clock, CGMVCLK, and the divided, CGMPCLK. The CGMPCLK is one of the reference clocks to the base clock selector circuit.
- Base clock selector circuit — This software-controlled circuit selects the one of three clocks as the base clock, CGMOUT: CGMXCLK, CGMXCLK divided by two, or CGMPCLK divided by two.

Figure 8-1 shows the structure of the CGM.

Figure 8-2 is a summary of the CGM registers.

8.4.4 Acquisition and Tracking Modes

The PLL filter is manually or automatically configurable into one of two operating modes:

- Acquisition mode — In acquisition mode, the filter can make large frequency corrections to the VCO. This mode is used at PLL start up or when the PLL has suffered a severe noise hit and the VCO frequency is far off the desired frequency. When in acquisition mode, the $\overline{\text{ACQ}}$ bit is clear in the PLL bandwidth control register. (See [8.6.2 PLL Bandwidth Control Register](#).)
- Tracking mode — In tracking mode, the filter makes only small corrections to the frequency of the VCO. PLL jitter is much lower in tracking mode, but the response to noise is also slower. The PLL enters tracking mode when the VCO frequency is nearly correct, such as when the PLL is selected as the base clock source. (See [8.4.8 Base Clock Selector Circuit](#).) The PLL is automatically in tracking mode when not in acquisition mode or when the $\overline{\text{ACQ}}$ bit is set.

8.4.5 Manual and Automatic PLL Bandwidth Modes

The PLL can change the bandwidth or operational mode of the loop filter manually or automatically. Automatic mode is recommended for most users.

In automatic bandwidth control mode (AUTO = 1), the lock detector automatically switches between acquisition and tracking modes. Automatic bandwidth control mode also is used to determine when the VCO clock, CGMVCLK, is safe to use as the source for the base clock, CGMOUT. (See [8.6.2 PLL Bandwidth Control Register](#).) If PLL interrupts are enabled, the software can wait for a PLL interrupt request and then check the LOCK bit. If interrupts are disabled, software can poll the LOCK bit continuously (during PLL start-up, usually) or at periodic intervals. In either case, when the LOCK bit is set, the VCO clock is safe to use as the source for the base clock. (See [8.4.8 Base Clock Selector Circuit](#).) If the VCO is selected as the source for the base clock and the LOCK bit is clear, the PLL has suffered a severe noise hit and the software must take appropriate action, depending on the application. (See [8.7 Interrupts](#) for information and precautions on using interrupts.)

Table 8-2. PRE 1 and PRE0 Programming

PRE1 and PRE0	P	Prescaler Multiplier
00	0	1
01	1	2
10	2	4
11	3	8

VPR1 and VPR0 — VCO Power-of-Two Range Select Bits

These read/write bits control the VCO's hardware power-of-two range multiplier E that, in conjunction with L (See [8.4.3 PLL Circuits](#), [8.4.6 Programming the PLL](#), and [8.6.4 PLL VCO Range Select Register](#).) controls the hardware center-of-range frequency, f_{VRS} . VPR1:VPR0 cannot be written when the PLLON bit is set. Reset clears these bits.

Table 8-3. VPR1 and VPR0 Programming

VPR1 and VPR0	E	VCO Power-of-Two Range Multiplier
00	0	1
01	1	2
10	2	4

NOTE: Do not program E to a value of 3.

8.6.2 PLL Bandwidth Control Register

The PLL bandwidth control register (PBWC):

- Selects automatic or manual (software-controlled) bandwidth control mode
- Indicates when the PLL is locked
- In automatic bandwidth control mode, indicates when the PLL is in acquisition or tracking mode
- In manual operation, forces the PLL into acquisition or tracking mode

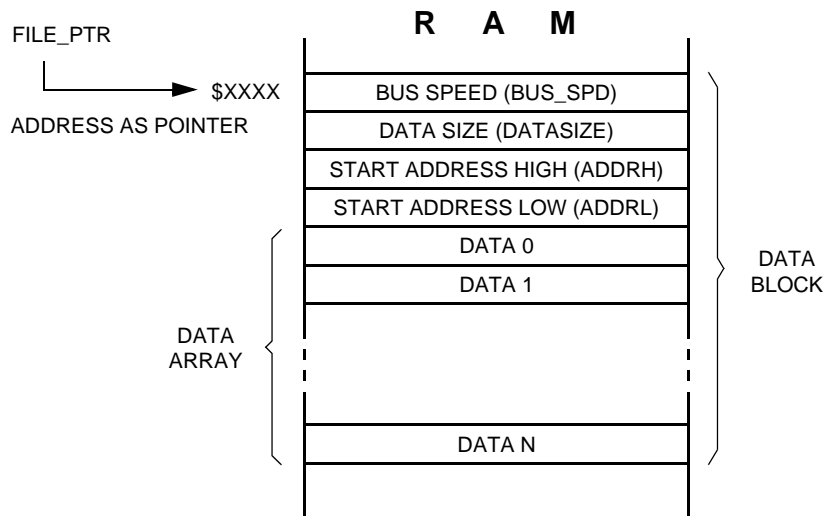


Figure 10-9. Data Block Format for ROM-Resident Routines

The control and data bytes are described below.

- **Bus speed** — This one byte indicates the operating bus speed of the MCU. The value of this byte should be equal to 4 times the bus speed. E.g., for a 4MHz bus, the value is 16 (\$10). This control byte is useful where the MCU clock source is switched between the PLL clock and the crystal clock.
- **Data size** — This one byte indicates the number of bytes in the data array that are to be manipulated. The maximum data array size is 255. Routines EE_WRITE and EE_READ are restricted to manipulate a data array between 2 to 15 bytes. Whereas routines ERARNGE and MON_ERARNGE do not manipulate a data array, thus, this data size byte has no meaning.
- **Start address** — These two bytes, high byte followed by low byte, indicate the start address of the FLASH memory to be manipulated.
- **Data array** — This data array contains data that are to be manipulated. Data in this array are programmed to FLASH memory by the programming routines: PRGRNGE, MON_PRGRNGE, EE_WRITE. For the read routines: LDRNGE, MON_LDRNGE, and EE_READ, data is read from FLASH and stored in this array.

Timer Interface Module (TIM)

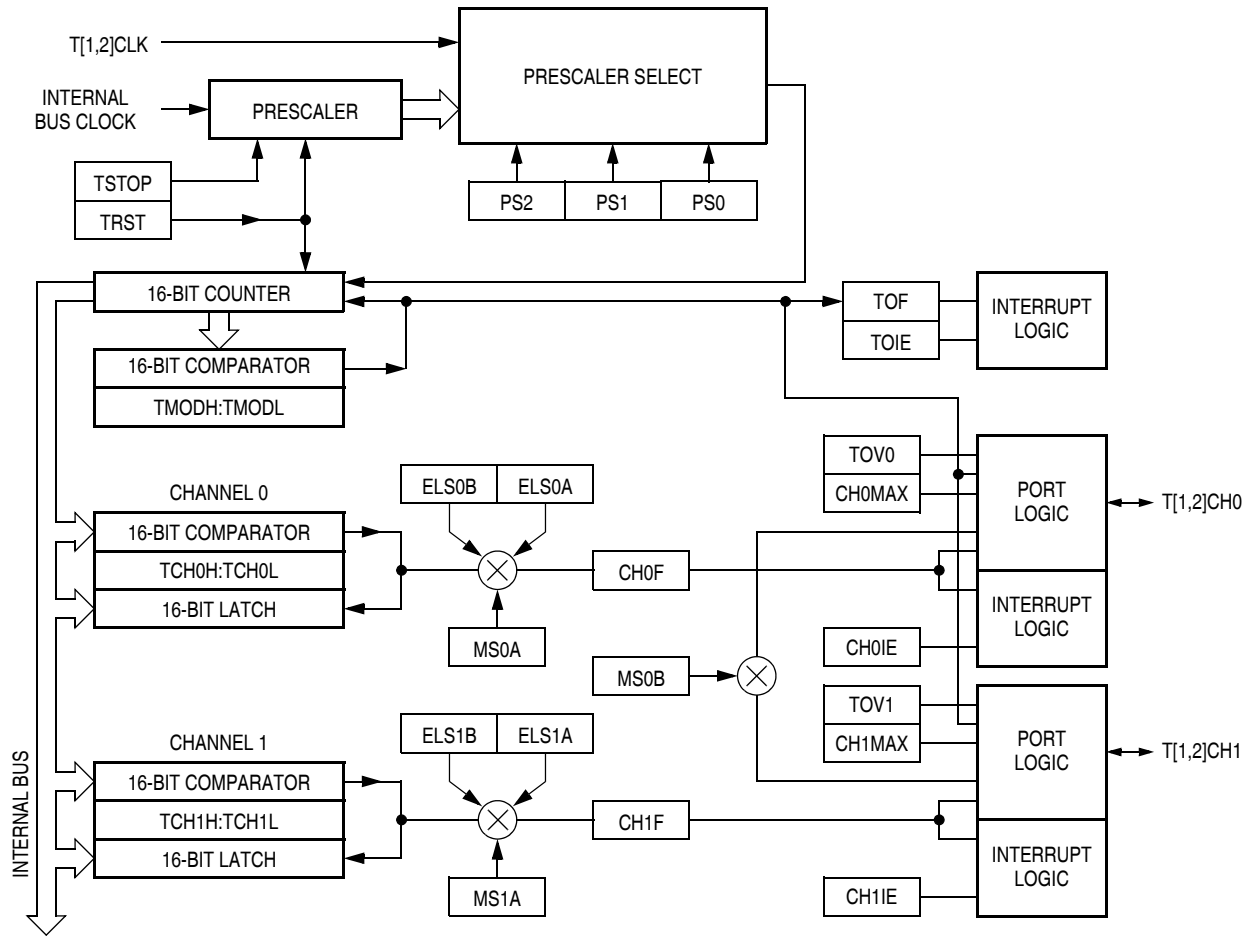


Figure 11-1. TIM Block Diagram

Figure 11-2 summarizes the timer registers.

NOTE: References to either timer 1 or timer 2 may be made in the following text by omitting the timer number. For example, TSC may generically refer to both T1SC and T2SC.

Use the following methods to synchronize unbuffered changes in the PWM pulse width on channel x:

- When changing to a shorter pulse width, enable channel x output compare interrupts and write the new value in the output compare interrupt routine. The output compare interrupt occurs at the end of the current pulse. The interrupt routine has until the end of the PWM period to write the new value.
- When changing to a longer pulse width, enable TIM overflow interrupts and write the new value in the TIM overflow interrupt routine. The TIM overflow interrupt occurs at the end of the current PWM period. Writing a larger value in an output compare interrupt routine (at the end of the current pulse) could cause two output compares to occur in the same PWM period.

NOTE: *In PWM signal generation, do not program the PWM channel to toggle on output compare. Toggling on output compare prevents reliable 0% duty cycle generation and removes the ability of the channel to self-correct in the event of software error or noise. Toggling on output compare also can cause incorrect PWM signal generation when changing the PWM pulse width to a new, much larger value.*

11.5.4.2 Buffered PWM Signal Generation

Channels 0 and 1 can be linked to form a buffered PWM channel whose output appears on the TCH0 pin. The TIM channel registers of the linked pair alternately control the pulse width of the output.

Setting the MS0B bit in TIM channel 0 status and control register (TSC0) links channel 0 and channel 1. The TIM channel 0 registers initially control the pulse width on the TCH0 pin. Writing to the TIM channel 1 registers enables the TIM channel 1 registers to synchronously control the pulse width at the beginning of the next PWM period. At each subsequent overflow, the TIM channel registers (0 or 1) that control the pulse width are the ones written to last. TSC0 controls and monitors the buffered PWM function, and TIM channel 1 status and control register (TSC1) is unused. While the MS0B bit is set, the channel 1 pin, TCH1, is available as a general-purpose I/O pin.

TB1F — Timebase 1 Flag

This clearable, read-only bit is set on every tick of the timebase 1 counter (every 0.5 or 0.125 seconds). When the TB1IE bit in RTCCR1 is set, TB1F generates a CPU interrupt request. In normal operation, clear the TB1F bit by reading RTCSR with TB1F set and then reading the chronograph data register (CHRR). Reset clears TB1F.

- 1 = A timebase 1 tick has occurred
- 0 = No timebase 1 tick has occurred

NOTE: *Timebase 1 is not synchronized to the compensated RTC 1-Hz clock. Hence, time intervals for timebase ticks may not align with the RTC clock and calendar register updates.*

TB2F — Timebase 2 Flag

This clearable, read-only bit is set on every tick of the timebase 2 counter (every 0.25 or 0.0625 seconds). When the TB2IE bit in RTCCR1 is set, TB2F generates a CPU interrupt request. In normal operation, clear the TB2F bit by reading RTCSR with TB2F set and then reading the chronograph register (CHRR). Reset clears TB2F.

- 1 = A timebase 2 tick has occurred
- 0 = No timebase 2 tick has occurred

NOTE: *Timebase 2 is not synchronized to the compensated RTC 1-Hz clock. Hence, time intervals for timebase ticks may not align with the RTC clock and calendar register updates.*

As the receiver samples an incoming character, it resynchronizes the RT clock on any valid falling edge within the character. Resynchronization within characters corrects misalignments between transmitter bit times and receiver bit times.

Slow Data Tolerance

Figure 13-10 shows how much a slow received character can be misaligned without causing a noise error or a framing error. The slow stop bit begins at RT8 instead of RT1 but arrives in time for the stop bit data samples at RT8, RT9, and RT10.

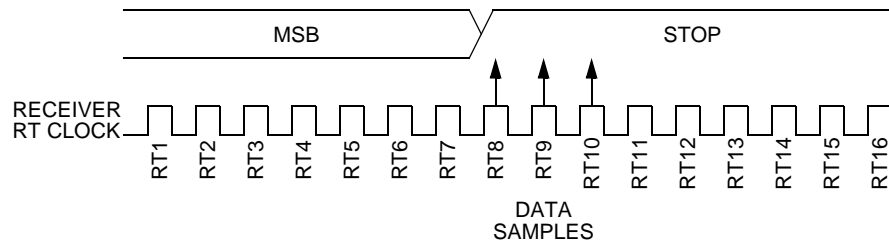


Figure 13-10. Slow Data

For an 8-bit character, data sampling of the stop bit takes the receiver 9 bit times \times 16 RT cycles + 10 RT cycles = 154 RT cycles.

With the misaligned character shown in **Figure 13-10**, the receiver counts 154 RT cycles at the point when the count of the transmitting device is 9 bit times \times 16 RT cycles + 3 RT cycles = 147 RT cycles.

The maximum percent difference between the receiver count and the transmitter count of a slow 8-bit character with no errors is

$$\left| \frac{154 - 147}{154} \right| \times 100 = 4.54\%$$

For a 9-bit character, data sampling of the stop bit takes the receiver 10 bit times \times 16 RT cycles + 10 RT cycles = 170 RT cycles.

With the misaligned character shown in **Figure 13-10**, the receiver counts 170 RT cycles at the point when the count of the transmitting device is 10 bit times \times 16 RT cycles + 3 RT cycles = 163 RT cycles.

(logic 1). Clearing and then setting TE during a transmission queues an idle character to be sent after the character currently being transmitted. Reset clears the TE bit.

- 1 = Transmitter enabled
- 0 = Transmitter disabled

NOTE: *Writing to the TE bit is not allowed when the enable SCI bit (ENSCI) is clear. ENSCI is in SCI control register 1.*

RE — Receiver Enable Bit

Setting this read/write bit enables the receiver. Clearing the RE bit disables the receiver but does not affect receiver interrupt flag bits. Reset clears the RE bit.

- 1 = Receiver enabled
- 0 = Receiver disabled

NOTE: *Writing to the RE bit is not allowed when the enable SCI bit (ENSCI) is clear. ENSCI is in SCI control register 1.*

RWU — Receiver Wakeup Bit

This read/write bit puts the receiver in a standby state during which receiver interrupts are disabled. The WAKE bit in SCC1 determines whether an idle input or an address mark brings the receiver out of the standby state and clears the RWU bit. Reset clears the RWU bit.

- 1 = Standby state
- 0 = Normal operation

SBK — Send Break Bit

Setting and then clearing this read/write bit transmits a break character followed by a logic 1. The logic 1 after the break character guarantees recognition of a valid start bit. If SBK remains set, the transmitter continuously transmits break characters with no logic 1s between them. Reset clears the SBK bit.

- 1 = Transmit break characters
- 0 = No break characters being transmitted

NOTE: *Do not toggle the SBK bit immediately after setting the SCTE bit. Toggling SBK before the preamble begins causes the SCI to send a break character instead of a preamble.*

13.11.3 SCI Control Register 3

SCI control register 3:

- Stores the ninth SCI data bit received and the ninth SCI data bit to be transmitted
- Enables the following interrupts:
 - Receiver overrun interrupts
 - Noise error interrupts
 - Framing error interrupts
 - Parity error interrupts

Address: \$0015

	Bit 7	6	5	4	3	2	1	Bit 0
Read:	R8	T8	DMARE	DMATE	ORIE	NEIE	FEIE	PEIE
Write:								
Reset:	U	U	0	0	0	0	0	0

= Unimplemented U = Unaffected

Figure 13-14. SCI Control Register 3 (SCC3)

R8 — Received Bit 8

When the SCI is receiving 9-bit characters, R8 is the read-only ninth bit (bit 8) of the received character. R8 is received at the same time that the SCDR receives the other 8 bits.

When the SCI is receiving 8-bit characters, R8 is a copy of the eighth bit (bit 7). Reset has no effect on the R8 bit.

T8 — Transmitted Bit 8

When the SCI is transmitting 9-bit characters, T8 is the read/write ninth bit (bit 8) of the transmitted character. T8 is loaded into the transmit shift register at the same time that the SCDR is loaded into the transmit shift register. Reset has no effect on the T8 bit.

PEIE — Receiver Parity Error Interrupt Enable Bit

This read/write bit enables SCI error CPU interrupt requests generated by the parity error bit, PE. (See [13.11.4 SCI Status Register 1](#).) Reset clears PEIE.

- 1 = SCI error CPU interrupt requests from PE bit enabled
- 0 = SCI error CPU interrupt requests from PE bit disabled

13.11.4 SCI Status Register 1

SCI status register 1 contains flags to signal these conditions:

- Transfer of SCDR data to transmit shift register complete
- Transmission complete
- Transfer of receive shift register data to SCDR complete
- Receiver input idle
- Receiver overrun
- Noisy data
- Framing error
- Parity error

Address: \$0016

	Bit 7	6	5	4	3	2	1	Bit 0
Read:	SCTE	TC	SCRF	IDLE	OR	NF	FE	PE
Write:								
Reset:	1	1	0	0	0	0	0	0

= Unimplemented

Figure 13-15. SCI Status Register 1 (SCS1)

SCTE — SCI Transmitter Empty Bit

This clearable, read-only bit is set when the SCDR transfers a character to the transmit shift register. SCTE can generate an SCI transmitter CPU interrupt request. When the SCTIE bit in SCC2 is set, SCTE generates an SCI transmitter CPU interrupt request. In normal

17.5.1 LCD Duty

The setting of the LCD output waveform duty is dependent on the number of backplane drivers required. Three LCD duties are available:

- Static duty — BP0 is used only
- 1/3 duty — BP0, BP1, and BP3 are used
- 1/4 duty — BP0, BP1, BP2, and BP3 are used

When the LCD driver module is enabled the backplane waveforms for the selected duty are driven out of the backplane pins. The backplane waveforms are periodic and are shown in [Figure 17-5](#), [Figure 17-6](#), and [Figure 17-7](#).

17.5.2 LCD Voltages (V_{LCD} , V_{LCD1} , V_{LCD2} , V_{LCD3})

The voltage V_{LCD} is from the V_{LCD} pin and must not exceed V_{DD} . V_{LCD1} , V_{LCD2} , and V_{LCD3} are internal bias voltages for the LCD driver waveforms. They are derived from V_{LCD} using a resistor ladder (see [Figure 17-3](#)).

The relative potential of the LCD voltages are:

- $V_{LCD} = V_{DD}$
- $V_{LCD1} = 2/3 \times (V_{LCD} - V_{bias})$
- $V_{LCD2} = 1/3 \times (V_{LCD} - V_{bias})$
- $V_{LCD3} = V_{bias}$

The V_{LCD3} bias voltage, V_{bias} , is controlled by the LCD contrast control bits, $LCCON[2:0]$.

17.5.3 LCD Cycle Frame

The LCD driver module uses the $CGMXCLK$ (see [Section 7. Oscillator \(OSC\)](#)) as the input reference clock. This clock is divided to produce the LCD waveform base clock, $LCDCLK$, by configuring the $LCLK[2:0]$ bits in the LCD clock register. The $LCDCLK$ clocks the backplane and the frontplane output waveforms.

20.5 Functional Description

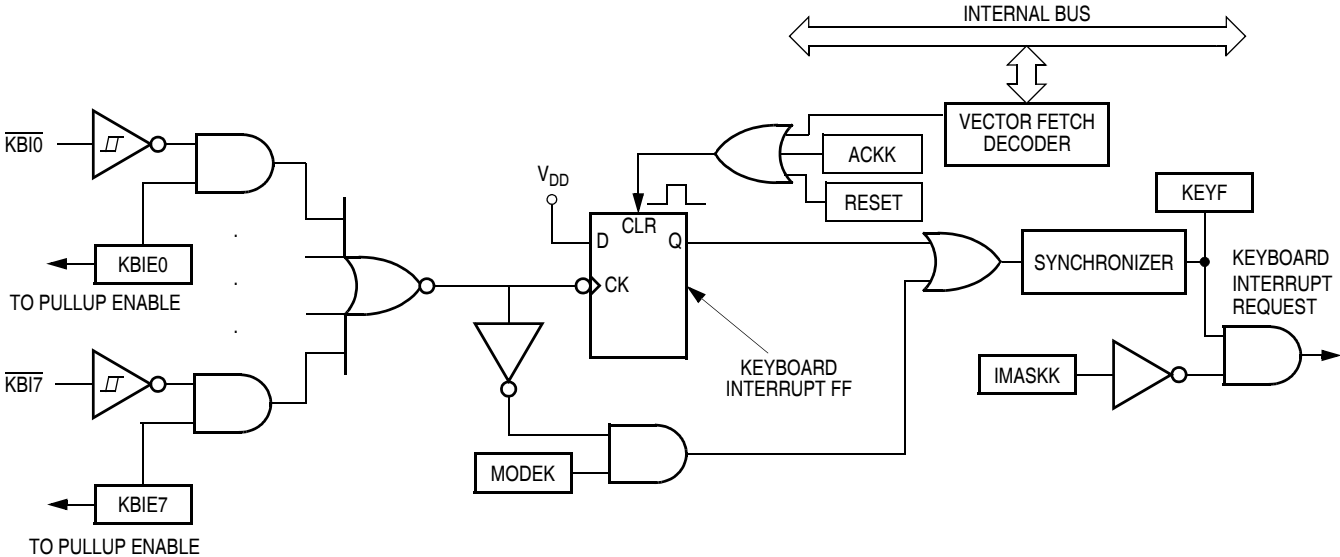


Figure 20-2. Keyboard Interrupt Block Diagram

Writing to the KBIE7–KBIE0 bits in the keyboard interrupt enable register independently enables or disables a port A or port D pin as a keyboard interrupt pin. Enabling a keyboard interrupt pin in port A or port D also enables its internal pullup device. A logic 0 applied to an enabled keyboard interrupt pin latches a keyboard interrupt request.

A keyboard interrupt is latched when one or more keyboard pins goes low after all were high. The MODEK bit in the keyboard status and control register controls the triggering mode of the keyboard interrupt.

- If the keyboard interrupt is edge-sensitive only, a falling edge on a keyboard pin does not latch an interrupt request if another keyboard pin is already low. To prevent losing an interrupt request on one pin because another pin is still low, software can disable the latter pin while it is low.
- If the keyboard interrupt is falling edge- and low level-sensitive, an interrupt request is present as long as any keyboard pin is low.

23.6.4 SIM Break Flag Control Register

The SIM break flag control register (SBFCR) contains a bit that enables software to clear status bits while the MCU is in a break state.

Address: \$FE03

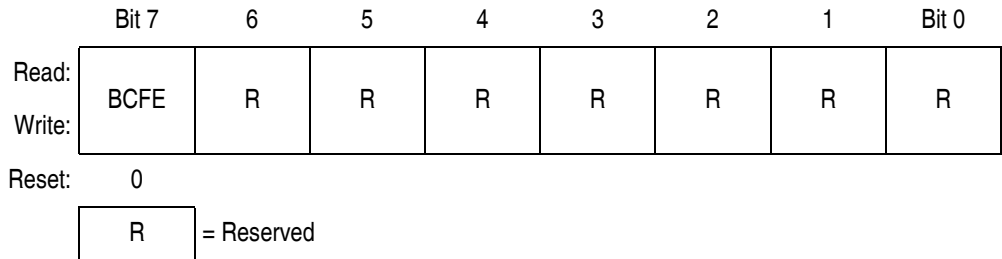


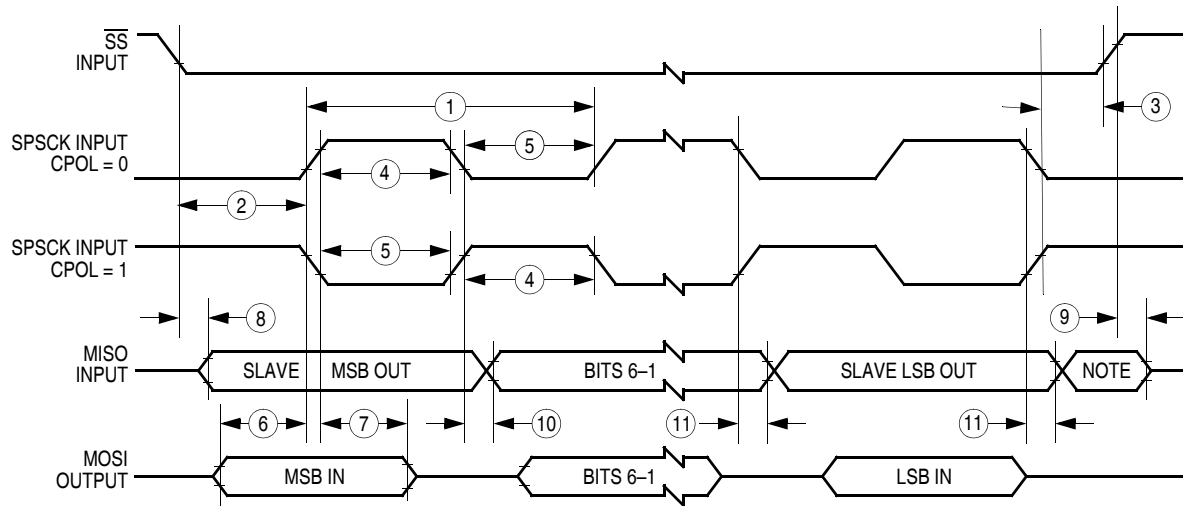
Figure 23-7. SIM Break Flag Control Register (SBFCR)

BCFE — Break Clear Flag Enable Bit

This read/write bit enables software to clear status bits by accessing status registers while the MCU is in a break state. To clear status bits during the break state, the BCFE bit must be set.

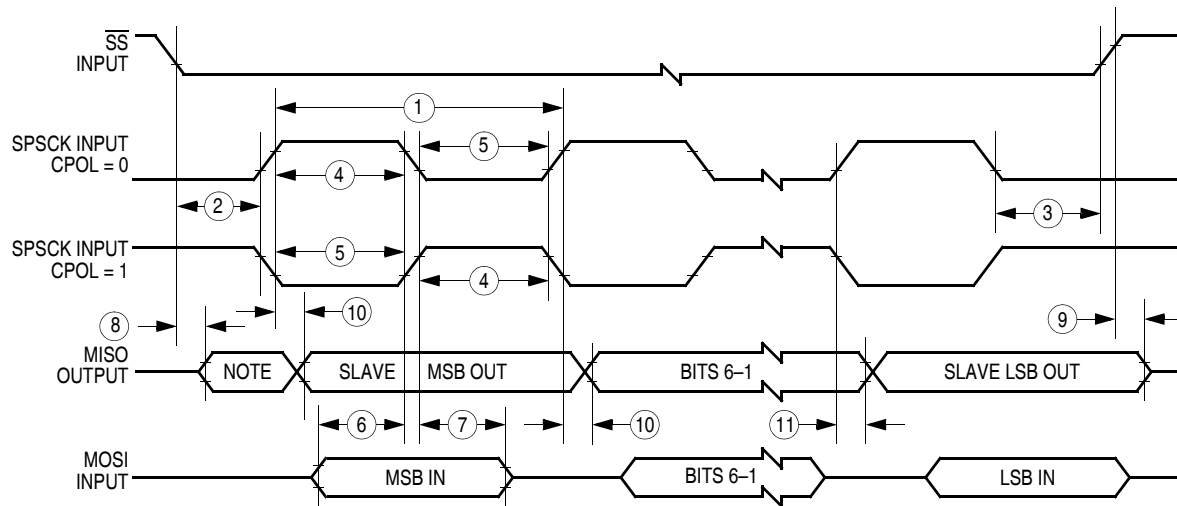
1 = Status bits clearable during break

0 = Status bits not clearable during break



Note: Not defined but normally MSB of character just received

a) SPI Slave Timing (CPHA = 0)



Note: Not defined but normally LSB of character previously transmitted

b) SPI Slave Timing (CPHA = 1)

Figure 24-3. SPI Slave Timing